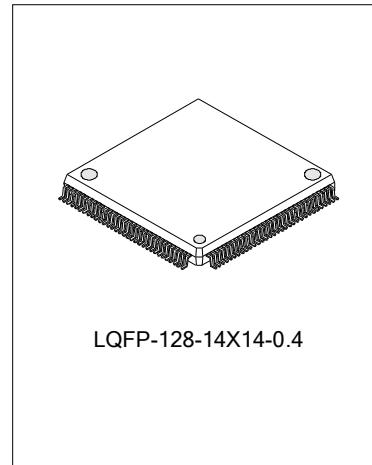




## VCD SIGNAL-CHIP PROCESSOR

### DESCRIPTION

SC9660 is a single chip SOC for VCD system, it integrates CD servo and correct decoder, Audio DAC, MPEG audio/video decode module and Video DAC. Working with the RF pre-processor of CD composes a low cost and high performance VCD system solution.



### FEATURES

- \* Periphery circuit is simple, servo and decoder integrated;
- \* Built-in TV code, support composite video, S-Video, PAL/NTSC video signal output;
- \* Compatible with VCD1.1 and VCD2.0 format;
- \* Kara OK function;
- \* Support CD-MP3 decode play;
- \* Embedded Audio DAC, PWM output;
- \* JPEG decode and play function;
- \* OSD function;
- \* Adopts CD servo arithmetic, strong correct function and good coherence;

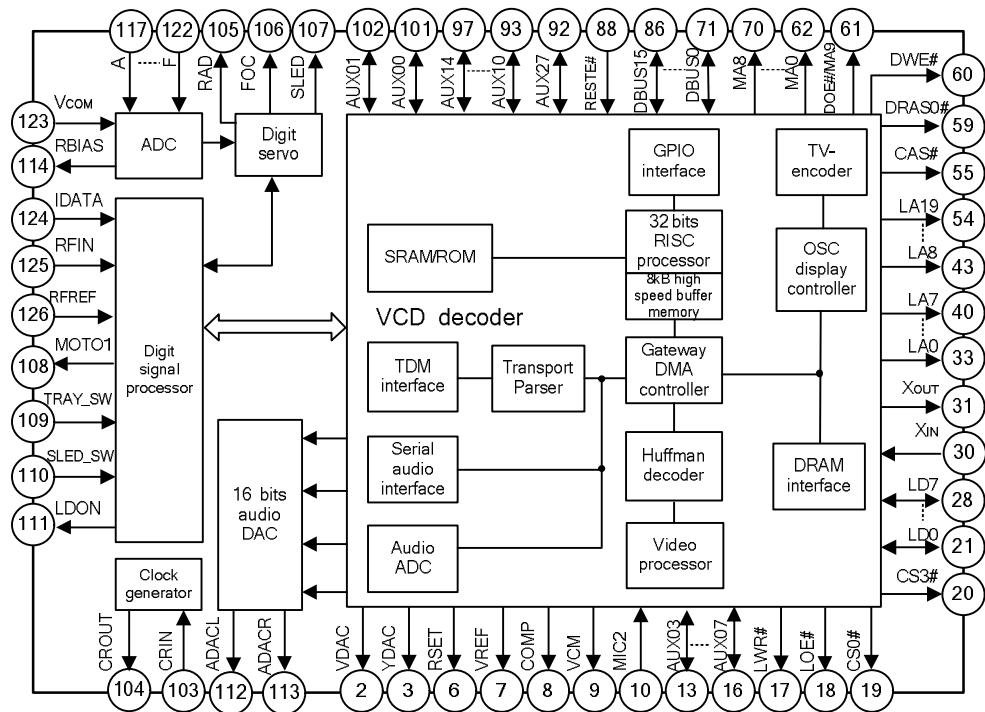
### ORDERING INFORMATION

Device	Package
SC9660	LQFP-128-14x14-0.4

### APPLICATION

\* VCD system

### BLOCK DIAGRAM

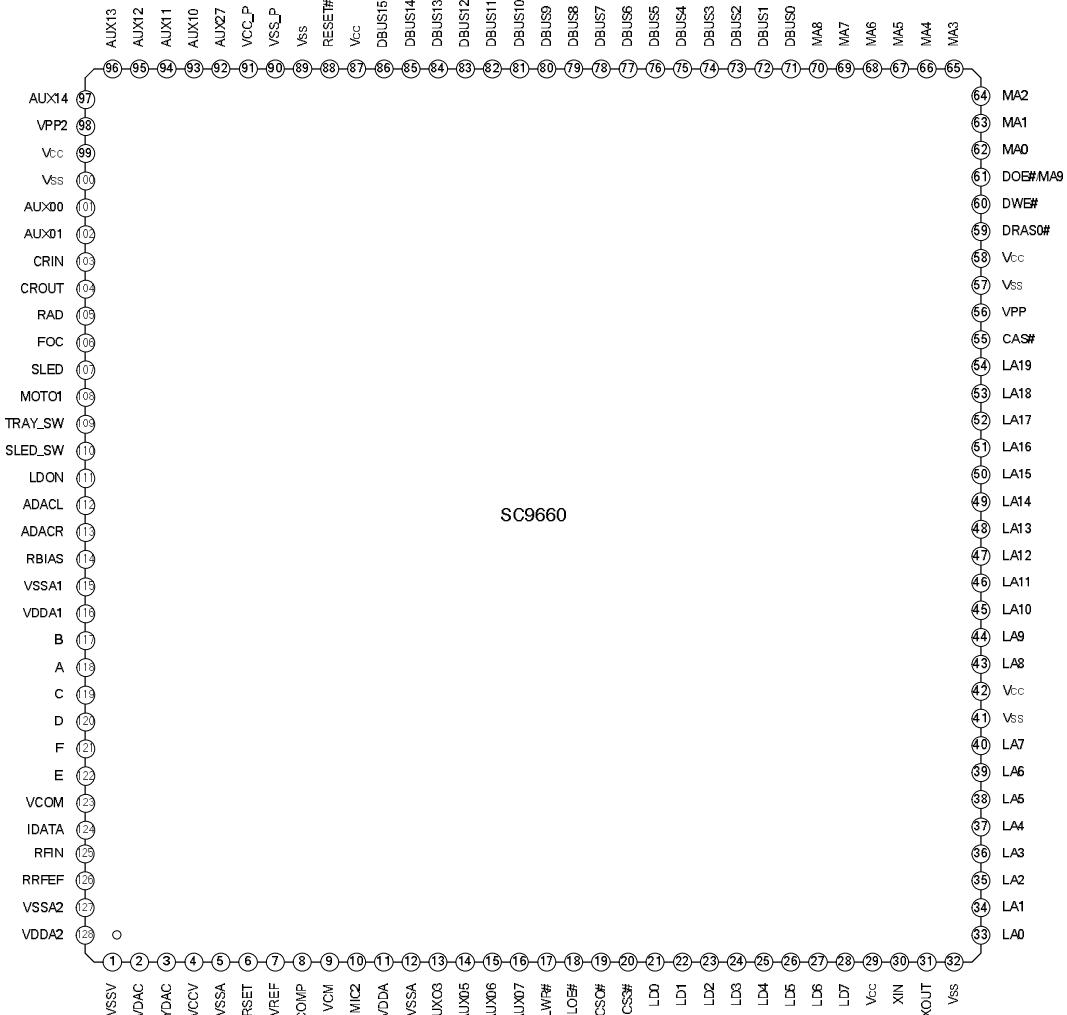


**ABSOLUTE MAXIMUM RATING**

Characteristics	Symbol	Rating	Unit
Power Supply Voltage	VDD	-0.5 ~ +5.5	V
Input Voltage on Pins	VIN	-0.5 ~VDD + 0.5	V
Operating Temperature	T <sub>opr</sub>	-20 ~ +75	°C

**ELECTRICAL CHARACTERISTICS** (unless otherwise specified, Tamb=25°C)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Operating Voltage	VDD		4.5	5	5.5	V
Operating Current	I <sub>DD</sub>		48	50	52	mA
Quiescent Current	I <sub>DD(q)</sub>	VDD=5V; Tamb=25°C	--	--	300	μA
Operating Temperature	T <sub>amb</sub>	VDD=5V; Tamb=25°C	-10	--	+80	°C
DAC Total Harmonic Distortion	THD	0dB 1KHz signal input	-	-65	-	dB
DAC output Signal to Noise	S/N	No signal input	-	75	-	dB

**PIN CONFIGURATION**


**PIN DESCRIPTION**

Pin no.	Pin name	I/O	Function
1	VSSV	I	VDAC ground.
2	VDAC	O	Video DAC V port output.
3	YDAC	O	Video DAC Y port output.
4	VCCV	I	Video DAC 2.5V power supply.
5, 12	VSSA	I	Analog ground.
6	RSET	O	Reset the internal current of generator; connect with a $510\Omega$ resistor to ground.
7	VREF	O	Output reference voltage, connect a $0.01\mu F$ high frequency filter capacitor to VSSA.
8	COMP	O	Compensation capacitance for low-pass filter on VDAC. Connect to a $0.01\mu F$ high-frequency bypass capacitor to VSSA.
9	VCM	O	ADC analog reference voltage, connect to a $0.01\mu F$ high frequency filter capacitor to VSSA.
10	MIC2	I	Microphone input.
11	VDDA	I	Analog 5.0V power supply.
13	AUX03	I/O	General-purpose programmable I/O.
14~16	AUX0[5:7]	I/O	General-purpose programmable I/O.
17	LWR#	O	RISC interface writable (low active).
18	LOE#	O	RISC static memory output (low active).
19	CS0#	O	Chip select 0 for SRAM.
20	CS3#	O	Chip select 3 for SRAM.
21~28	LD[0:7]	I/O	Data bus.
29	Vcc	I	Main power supply 2.5V
42			
58			
87			
99			
30	XIN	I	27MHz crystal oscillator input, the duty is 50%.
31	XOUT	O	Input clock crystal oscillator output.
32	VSS	I	Main ground.
41			
57			
89			
100			
33~40	LA[0:7]	O	Address bus.
43~54	LA[8:19]	O	Address bus.
55	CAS#	O	Column address filter to dynamic memory (low active).
56	VPP	I	5V power supply.
59	DRAS0#	O	Row address filter to dynamic memory.

(To be continued)

(Continued)

<b>Pin no.</b>	<b>Pin name</b>	<b>I/O</b>	<b>Function</b>
60	DWE#	O	Writable dynamic memory (low active).
61	DOE#/MA9	O	Output data to dynamic memory (low active), Multivariate memory row and column address.
62~70	MA[0:8]	O	Multivariate memory row and column address.
71~86	DBUS[0:15]	I/O	Input/output when Dynamic memory read/write.
88	RESET#	I	External system reset will make ES3890 reset.
90	VSS_P	I	PLL system ground.
91	VCC_P	I	PLL system 2.5V power supply.
92	AUX27	I/O	General-purpose programmable I/O.
93~97	AUX1[0:4]	I/O	General-purpose programmable I/O.
98	VPP2	I	5V power supply.
101~102	AUX0[0:1]	I/O	General-purpose programmable I/O.
103	CRIN	I	8M crystal oscillator input of Servo unit.
104	CROUT	O	8M crystal oscillator output of Servo unit.
105	RAD	O	Tracking driver signal.
106	FOC	O	Focus driver signal.
107	SLED	O	Sled motor driver signal.
108	MOTO1	O	Spindle motor driver signal.
109	TRAY_SW	I	Tray position monitor signal input.
110	SLED_SW	I	Sled motor position monitor signal input.
111	LDON	O	Laser control signal output.
112	ADACL	O	Audio DAC left channel output.
113	ADACR	O	Audio DAC right channel output.
114	RBIAS	O	Internal resistor adjust.
115	VSSA1	I	Analog ground 1 for servo unit.
116	VDDA1	I	Analog power supply 1 for servo unit.
117	B	I	Central diode current signal input 1
118	A	I	Central diode current signal input 2
119	C	I	Central diode current signal input 3
120	D	I	Central diode current signal input 4
121	F	I	Satellite diode current signal input
122	E	I	Satellite diode current signal input
123	VCOM	I	DC voltage input pin
124	IDATA	I	Output feedback current of data signal.
125	RFIN	I	CD pick up signal input.
126	RFREF	I	CD pick up signal reference voltage.
127	VSSA2	I	Analog ground 2 for servo unit.
128	VDDA2	I	Analog power supply 2 for servo unit.

## FUNCTION DESCRIPTON

SC9660 is a single chip SOC for VCD system, it integrates CD servo and correct decoder, Audio DAC, MPEG audio/video decode module and Video DAC. Working with the RF pre-processor of CD composes a low cost and high performance VCD system solution.

### CD servo decode module

CD servo decoder is the main module of SC9660, it can perform the CD servo and decode function, and support single/double speed switch, compatible with CD/CD-R/CD-RW.

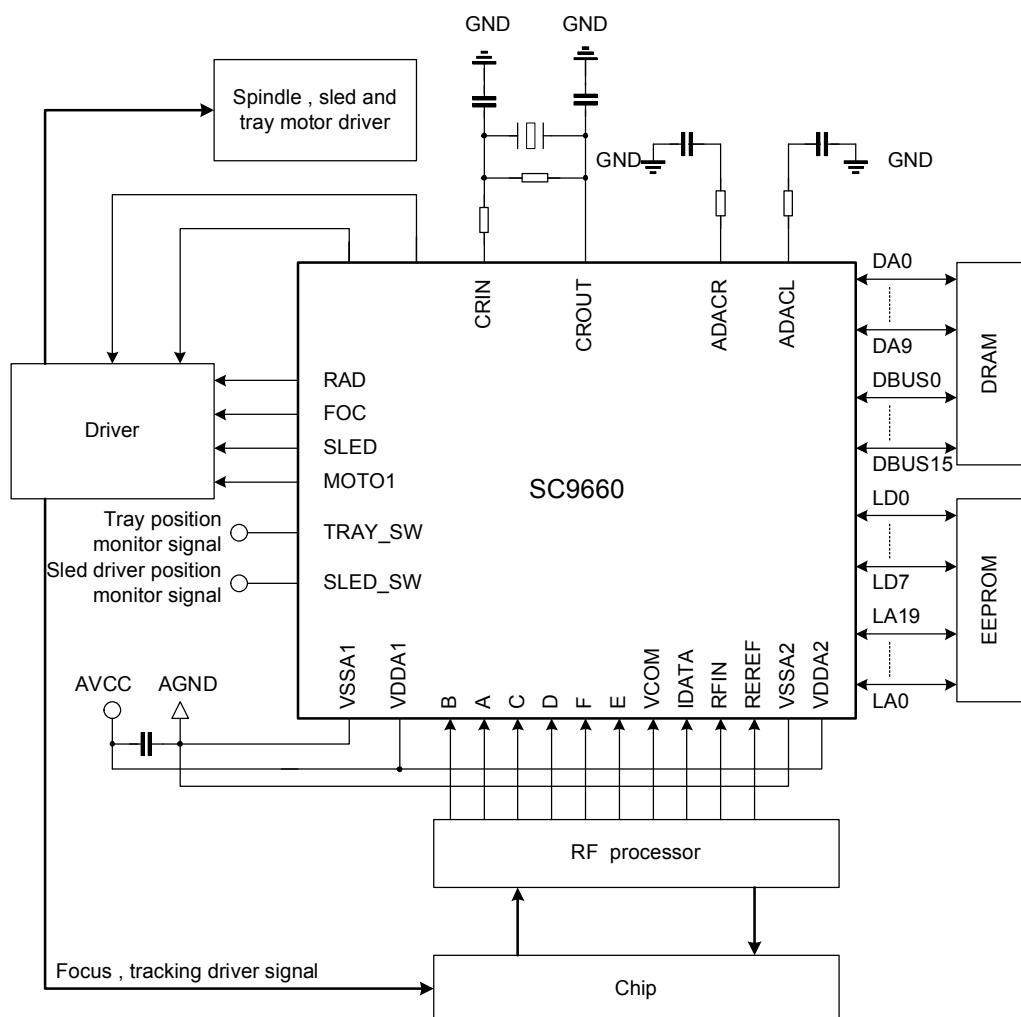
### Audio DAC module

This unit is 16 bits audio DAC, output PWM waveform, and connect to low-filter.

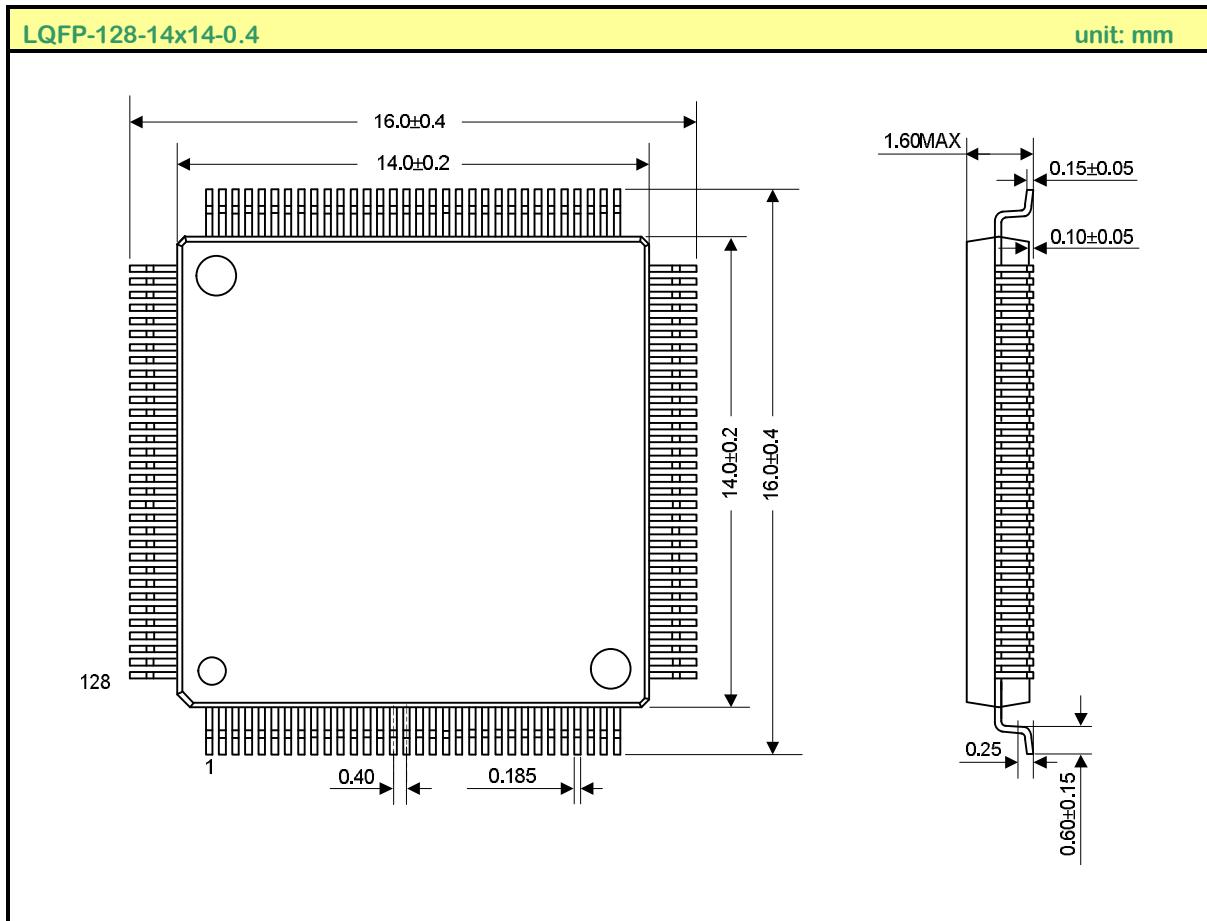
### VCD decode module

This module has VCD video decode and video DAC functions.

## TYPICAL APPLICATION CIRCUIT



## PACKAGE OUTLINE



### HANDLING MOS DEVICES:

Electrostatic charges can exist in many things. All of our MOS devices are internally protected against electrostatic discharge but they can be damaged if the following precautions are not taken:

- Persons at a work bench should be earthed via a wrist strap.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed for dispatch in antistatic/conductive containers.

## ATTACHMENT

## Revision History

Data	REV	Description	Page
2006.09.20	1.0	Original	
2006.12.31	1.1	Modify the "BLOCK DIAGRAM" , "ELECTRICAL CHARACTERISTICS" and "PIN DESCRIPTIONS"	

Note: Silan reserves the right to make changes without notice in this specification for the improvement of the design and performance.  
Silan will supply the best possible product for customers.